

## YL-VC850-751

### High Performance 10 Gbps Oxide VCSEL

*Preliminary*

#### FEATURES:

- Capable to run 10 Gbps
- P and N bonding pad on different surface
- Low divergence angle to ensure high optical coupling efficiency
- Wide operation temperature range -40°C ~ 85°C



#### ELECTRO-OPTICAL CHARACTERISTICS:

PARAMETERS	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITIONS
Threshold Current	$I_{th}$		0.8	1.2	mA	
Output Power	$P_o$		2.3		mW	$I_F=6$ mA
Slope Efficiency	$\eta$	0.25	0.45	0.65	mW/mA	$I_F=6$ mA
Wavelength	$\lambda_p$	840		860	nm	$I_F=6$ mA
Forward Voltage	$V_F$		2.1	2.4	V	$I_F=6$ mA
Series Resistance	$R_S$		85	115	$\Omega$	$I_F=6$ mA
Beam Divergence	$\theta$	15		35	degree	$I_F=6$ mA (1/e <sup>2</sup> )
Spectral width (RMS)	$\Delta \lambda$			0.65	nm	$I_F=6$ mA
Rise Times (20%~80%)	$T_r$		40		ps	$I_F=6$ mA
Fall Times (20%~80%)	$T_f$		40		Ps	$I_F=6$ mA
3dB Bandwidth	BW	8			GHz	$I_F=6$ mA

Notes:

All parameters except mentioned are measured at  $I_F=6$  mA, 25°C, CW operation.

#### ABSOLUTE MAXIMUM RATINGS:

PARAMETERS	MIN	MAX	UNIT	CONDITIONS
Storage Temperature	-40	125	°C	
Operating Temperature	-40	85	°C	
Continuous Forward Current		10	mA	
Continuous Reverse Voltage		5	V	10 $\mu$ A

Fig. 1 Typical Optical Characteristics

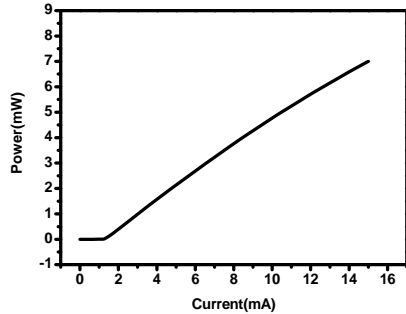
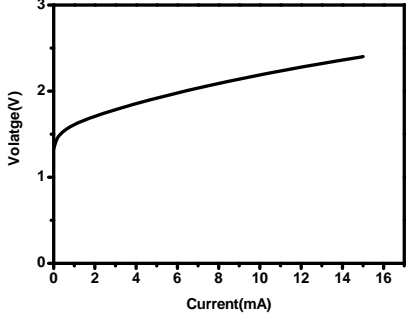
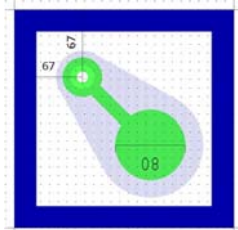


Fig. 2 Typical Electrical Characteristics



**OUTLINE DIAGRAM:**

- Chip length: 230  $\mu\text{m}$
- Chip width: 230  $\mu\text{m}$
- Chip thickness: 200  $\pm$  20  $\mu\text{m}$



**WARNING:**

The VCSEL is a class 3B laser in the safety standard IEC 60825:2014 and should be treated to avoid exposure to beam .

